

Fraunhofer Institute for Photonic Microsystems IPMS

Microelectronics meets Quantum Computing An Overview of Fraunhofer IPMS' Approach

NY CREATES Seminar, May 2024

Dr. Benjamin Lilienthal-Uhlig Fraunhofer IPMS

• Quantum Computing ?!

FROM

180

• Impressions on current State of Play

1.01

100001001

- Challenges... \rightarrow Microelectronics ?
- Short interlude about Fraunhofer
- Solutions & ideas & Some examples
- European strategy

Quantum Computing ?!

The quantum technology ecosystem in 2023

Summary of Quantum Technology Monitor findings



¹ The potential 2040 market size is a sum of the upper ranges across quantum computing, quantum communications, and quantum sensing.

² Total includes 32 companies that do two or more quantum technologies simultaneously.

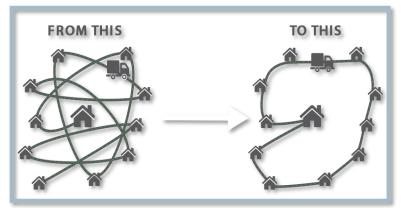
^a Economic value is defined as the additional revenue and saved costs that the application of quantum computing can unlock. These four industries are the most likely to realize this value earlier than other industries; therefore, they are examined in more depth.

Applications in the future

- Medical and Health
- Material Science
- Logistics and Traffic
- Finance

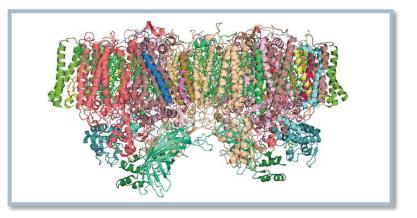
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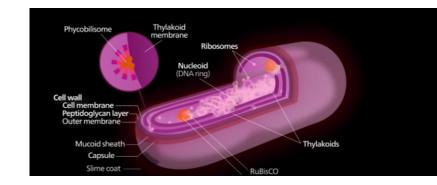




Example from Quantum Chemistry

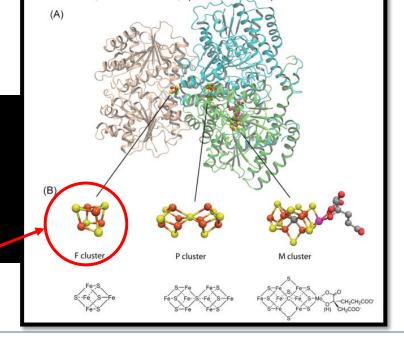


Low efficiency High energy consumption



Cyanobacteria (and many other life forms) can produce ammonia at room temperature!!

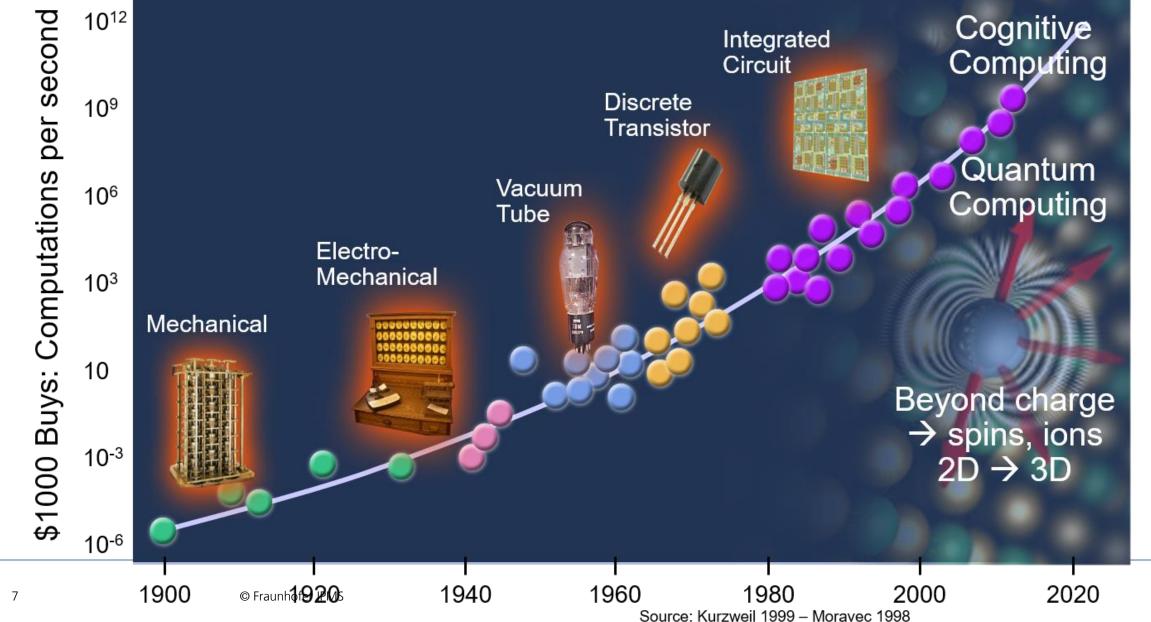
Only this can be simulated classically



MoFe protein

Fe protein

Technology Eras - Computing



How we did, do or will compute

Big Picture



analog

deterministic

sequential

usefull

Classical computer (1950)



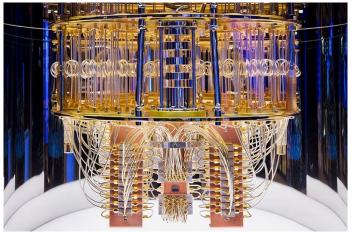
digital

deterministic

sequential

really usefull !

Quantum computer (20xy)



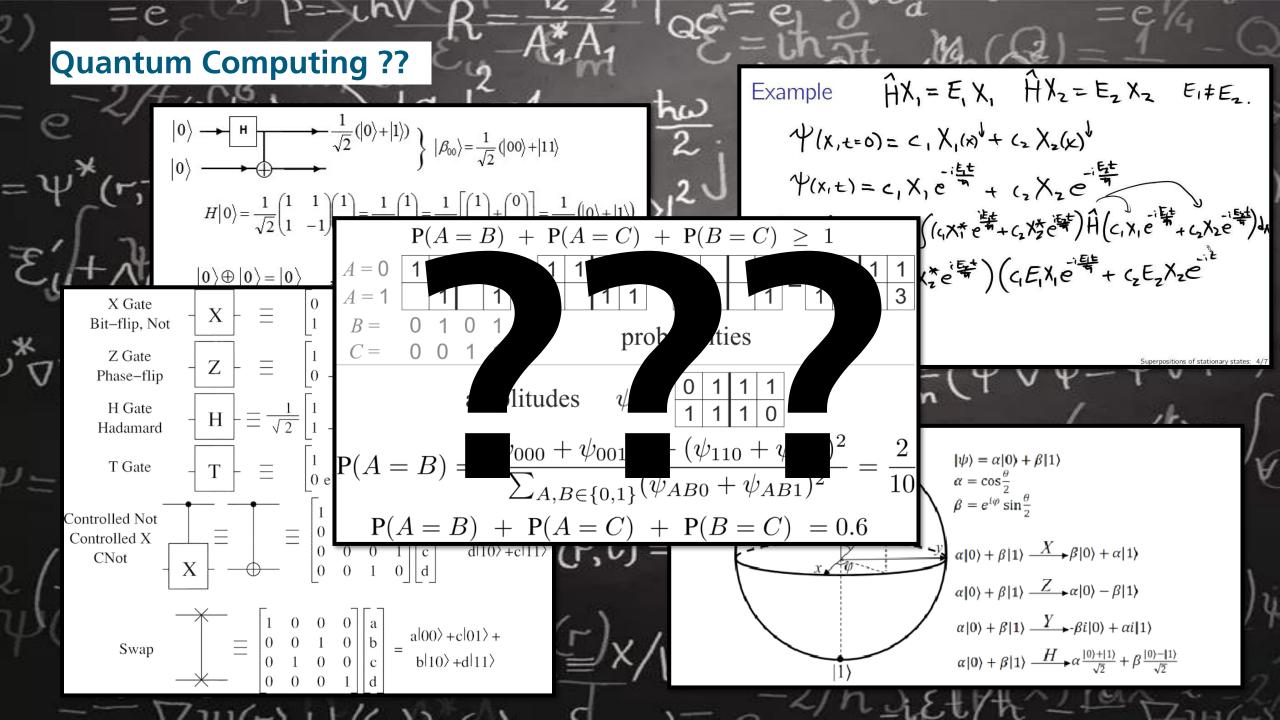
somehow digital, but it's complicated

,probabilistic'

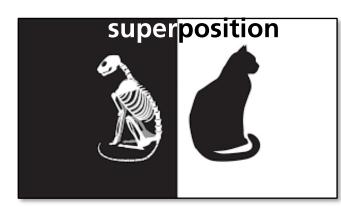
parallel

not yet usefull, **but HUGE potential !** (for specific problems) Simulation, optimization, machine learning, finance...



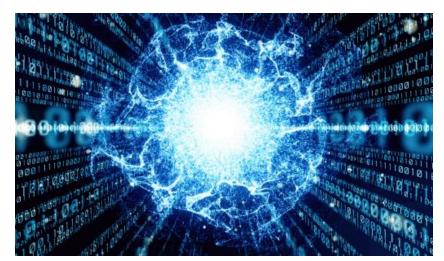


Quantum Computing ?



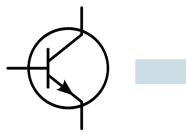




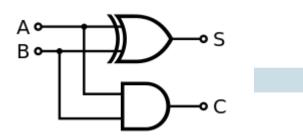


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Quantum Computing (!)



Transistor \rightarrow Bit

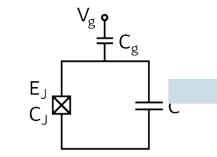


classical half adder



Integrated circuits





 $|A\rangle \qquad |A\rangle \\ |B\rangle \qquad |B\rangle \\ |C_{in}\rangle \qquad |S\rangle \\ |0\rangle \qquad |C_{out}\rangle$

Transmon \rightarrow QuBit

adder with quantum gates



Photonic quantum system

State of Play

The Qubit level: different platforms

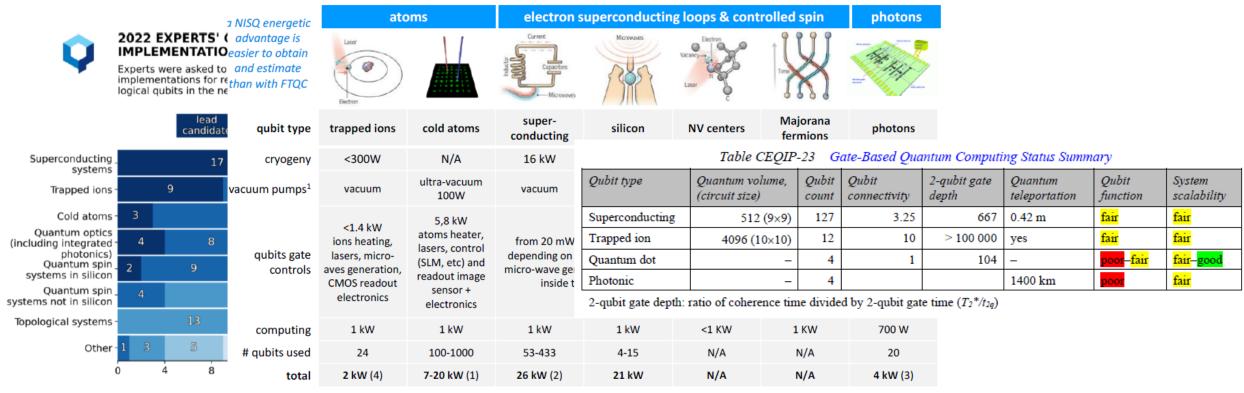


Figure 18: quantum computing experts trust on ions qubits. A few are trusting photonic and spi Global Risk Institute ¹³.

typical configurations for Pasqal (1), Google Sycamore with 53 qubits (2), Quandela/QuiX (3), AQT (4) rough estimates for others

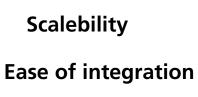
Figure 30: existing QPU typical power drain and their source. Caveat: none of these systems provide a quantum advantage at this point in time (2023). Source: (cc) Olivier Ezratty, 2023.

1 : fixed energetic cost, for preping stage

Which Qubit platform "wins" ?

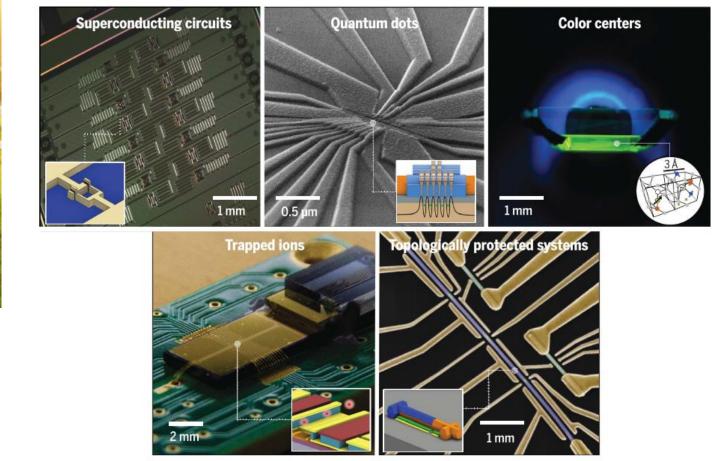


Coherence time Fidelity

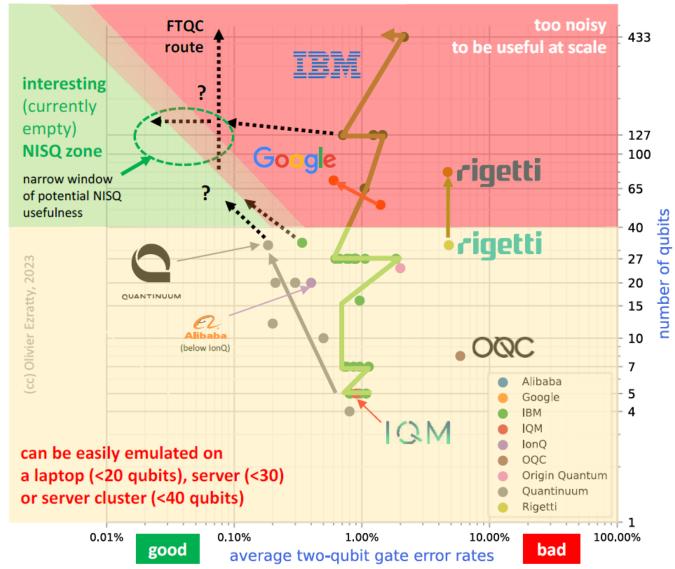


Ability to control

• • •



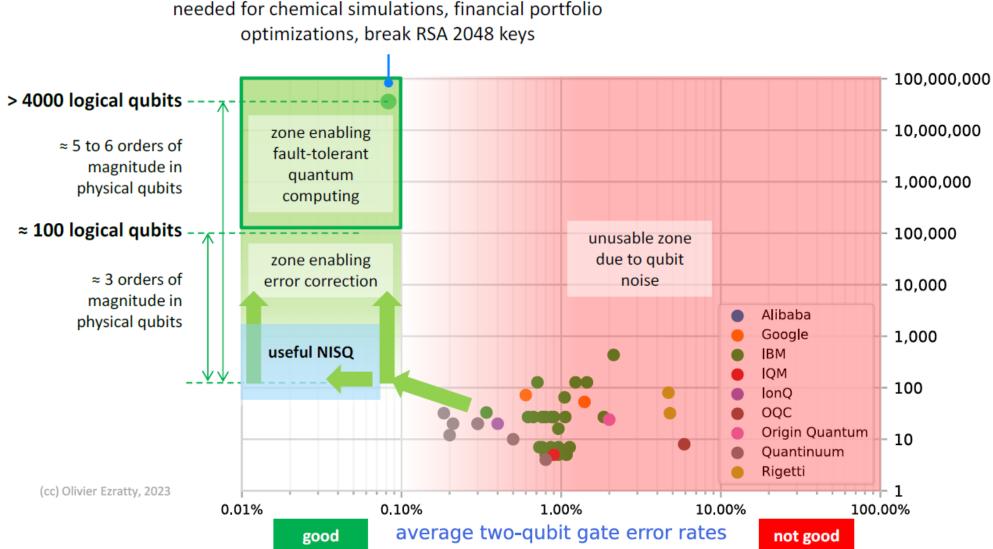
Current status for NISQ (more detailed)



Source: Olivier Ezratty, Kordzanganeh et al 10 and vendors two-qubit gate fidelities data obtained with randomized benchmarking

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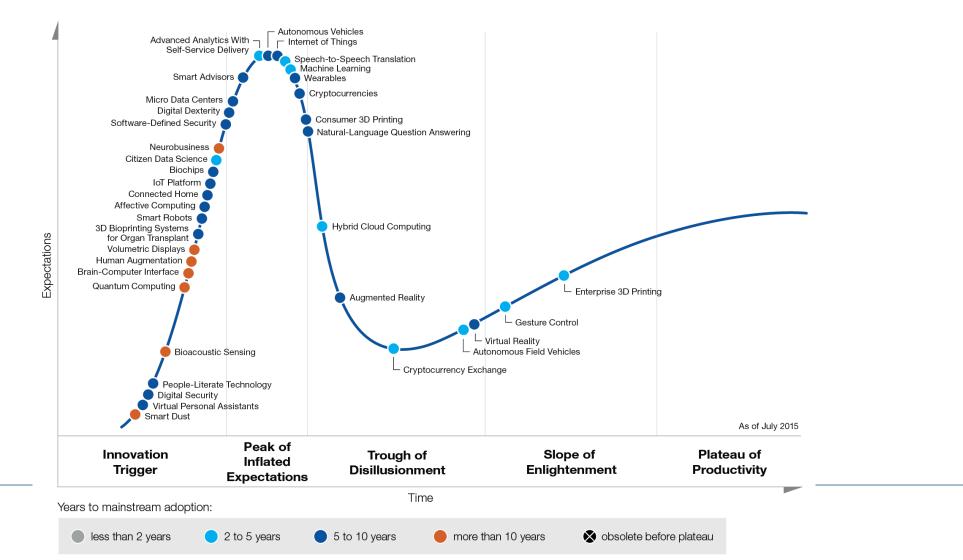
From NISQ to FTQC



© Fraunhofer IPMS Source: Olivier Ezratty, and vendor data, 2023

Quantum Computing in the Gartner Hypecycle

Emerging Technology Hype Cycle



Challenges and Microelectronics

Plenty of challenges

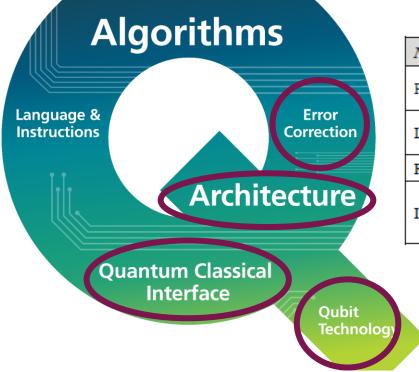


Table CEQIP-25 Diff	icult Challenges for QIP
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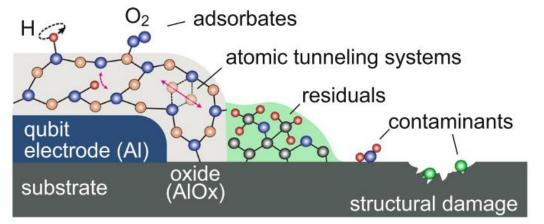
Near-Term Challenges: 2022–2028	Summary of Issues and Opportunities
Physical qubits	Design and fabrication of qubit devices with enhanced qubit coherence times and gate fidelities
Logical qubits	Implementation of fully error-corrected logical qubits and protected gate operations
Readout of qubits	Development of scalable, cryogenic qubit readout hardware
Interconnects, cryogenic to room temperature	Development of low thermal conductance and high bandwidth interconnects between different temperature stages of cryogenic- and room-temperature electronics

Challenges with Qubit Fabrication

e.g.for superconducting qubits

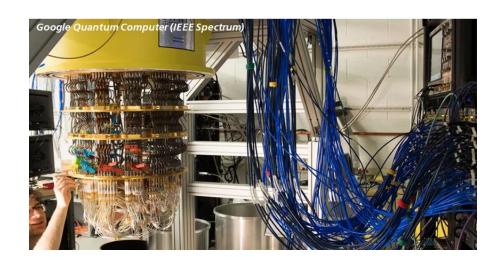
- Sensitivity to noise and losses
- Material and process imperfections
- Well defined, uniform and tight junction properties

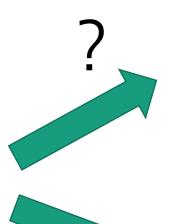
 \rightarrow explore new material and better process capabilities, beyond the labs



Quantum-Classical Interface: the problem of Interconnects

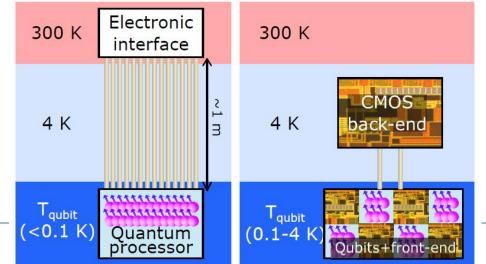
Incoming ,wiring apocalypse'







a) State of the art b) Future perspective



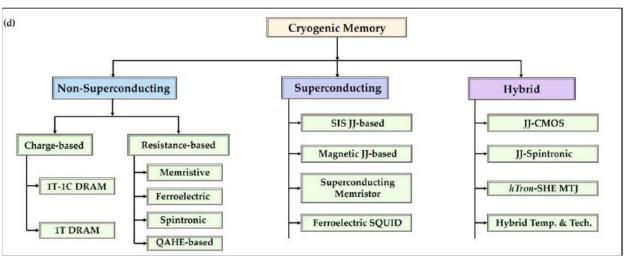
IBM

Algorithms

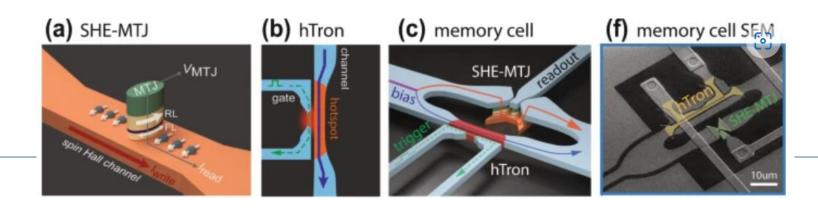
Error

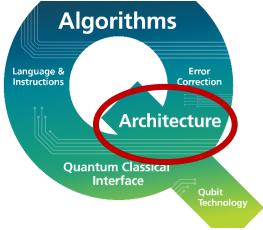
Architecture

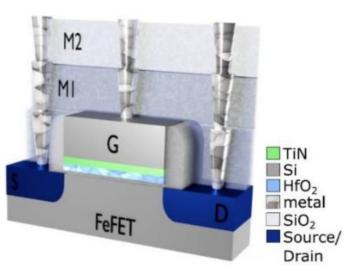
Quantum Memory



https://doi.org/10.48550/arXiv.2111.09436



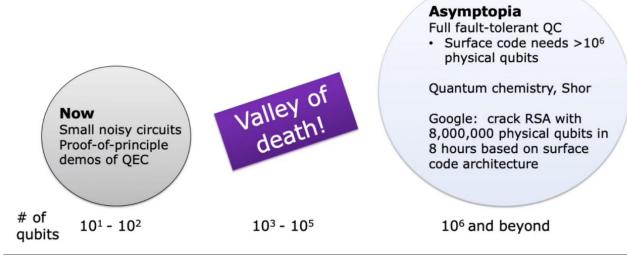




Do numbers matter?

Major qubit challenges:

- A) fidelity and coherence
- B) number



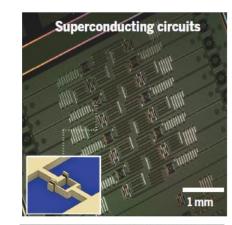
Quantum Motion

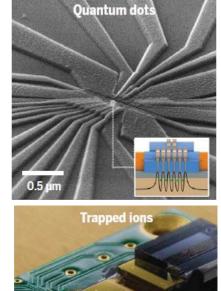
"Is there a technology that can reliably create billions of components on a chip and which is feasible for quantum computing?"

→ Microelectronics' Semiconductor manufacturing

Modern Semiconductor Manufacturing is needed for (large scale) Quantum Computing !

- Number of qubits
- Error correction, size of quantum algorithms
- Variability, process control and yield
- Improve qubit uniformity, coherence time and gate fidelity
- Interconnects
- Spatial limitations, thermal budget, wiring ,apocalypse'
- Interface to classical electronics
- ✤ CMOS control electronics, Advanced packaging, variability control, FDSOI, …
- Applicable to most platforms (SC, spin, ion trap, photonics, ...)
- Relevant players also focusing on wafer level semiconductor manufacturing
- ✤ Intel, imec, CEA, PsiQuantum (with Globalfoundries), ...







Short interlude about Fraunhofer

Fraunhofer-Gesellschaft

At a Glance

- > Largest Organization for Applied Research in Europe
- Focusing on key future-relevant technologies
- > Commercialization of findings in business and industry

Joseph von Fraunhofer (1787-1826)

Scientist, inventor and entrepreneur





The Fraunhofer-Gesellschaft

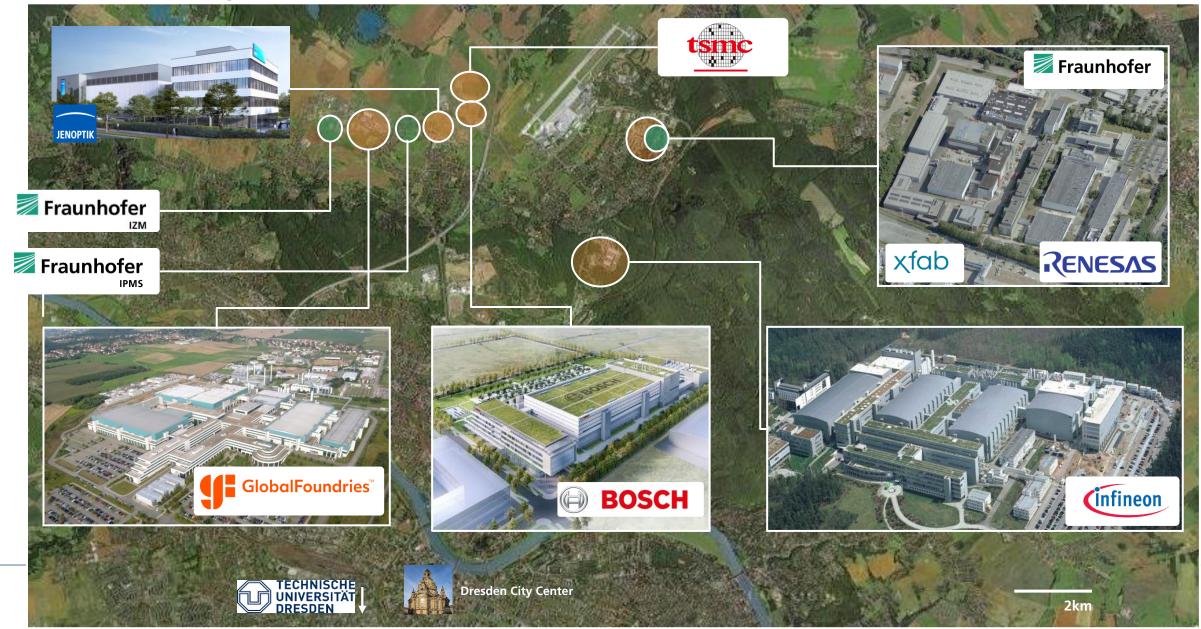
International network



- Eight independent international Fraunhofer affiliates
- Activities with partners in approximately 80 countries
- Representative offices and senior advisors around the world build bridges to local markets



Silicon Saxony - The heart of European Microelectronics beats in Dresden





At a Glance

- 565 employees
- € 56 M annual revenue
- € 26 M industry contracts (thereof)

R&D Focus:

- Photonic microsystems (200mm)
 Micro- and Nanoelectronic technologies (300mm)

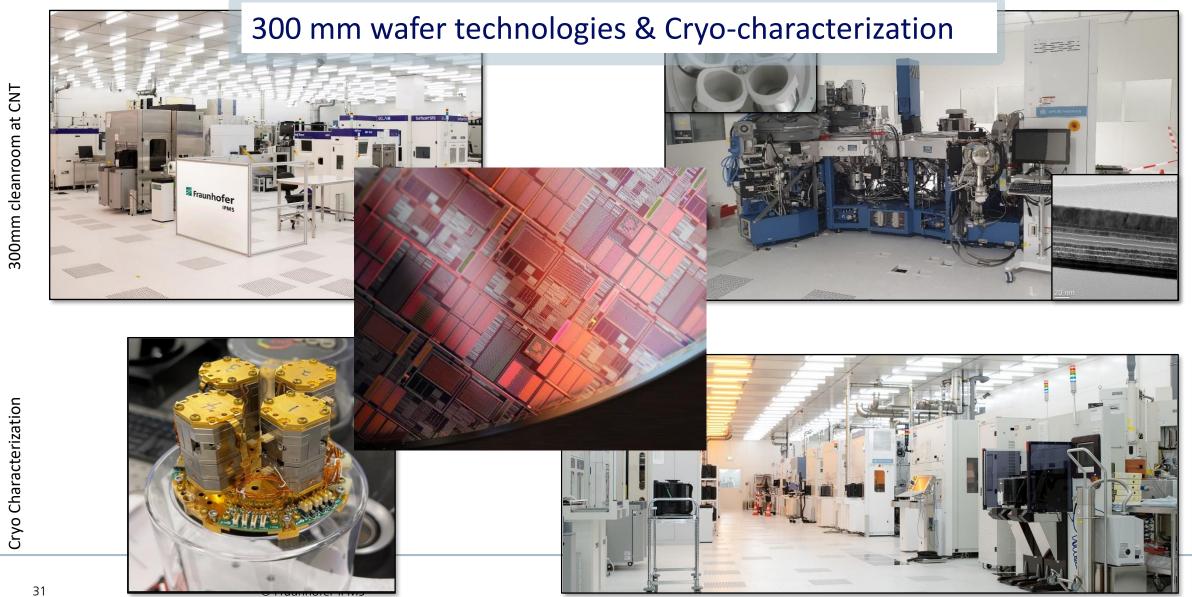
Fraunhofer IPMS – Center Nanoelectronic Technologies (CNT)



IPMS-CNT's research focus:

- ✤ Non-Volatile Memories (NVM)
- Screening Fab Services incl. process development in Back-End-of-Line module
- ✤ AI Fab with focus on Edge AI System Integration and Compute-In-Memory concepts
- Quantum Computing

FhG-IPMS capabilities for QC



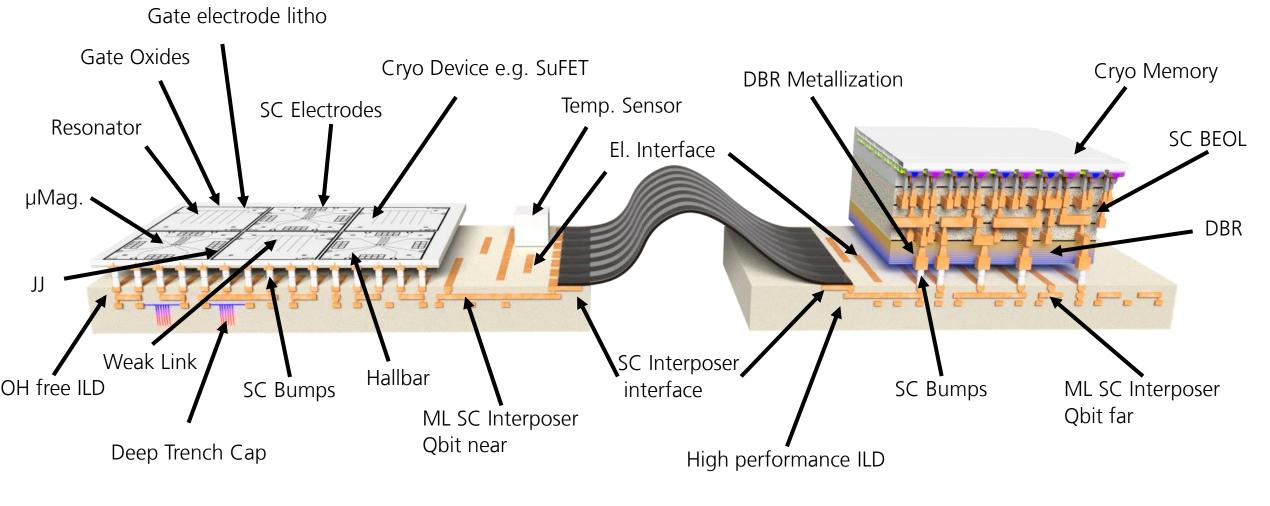
300mm cleanroom at CNT

300mm cleanroom at CNT

Solutions (or at least ideas !) with a few examples

Building blocks for integrated QC-systems

Neuromophic Error Correction



Advanced Substrates

Current project engagement for Superconducting Qubits



- QSOLID project (FZ Jülich): build a large scale German quantum computer
- MATQ project: Set up European supply chain and eco system for superconducting QC
- Task IPMS:

Multi target PVD for superconducting devices and qubits, resonator fabrication, packaging solutions, cryo characterization



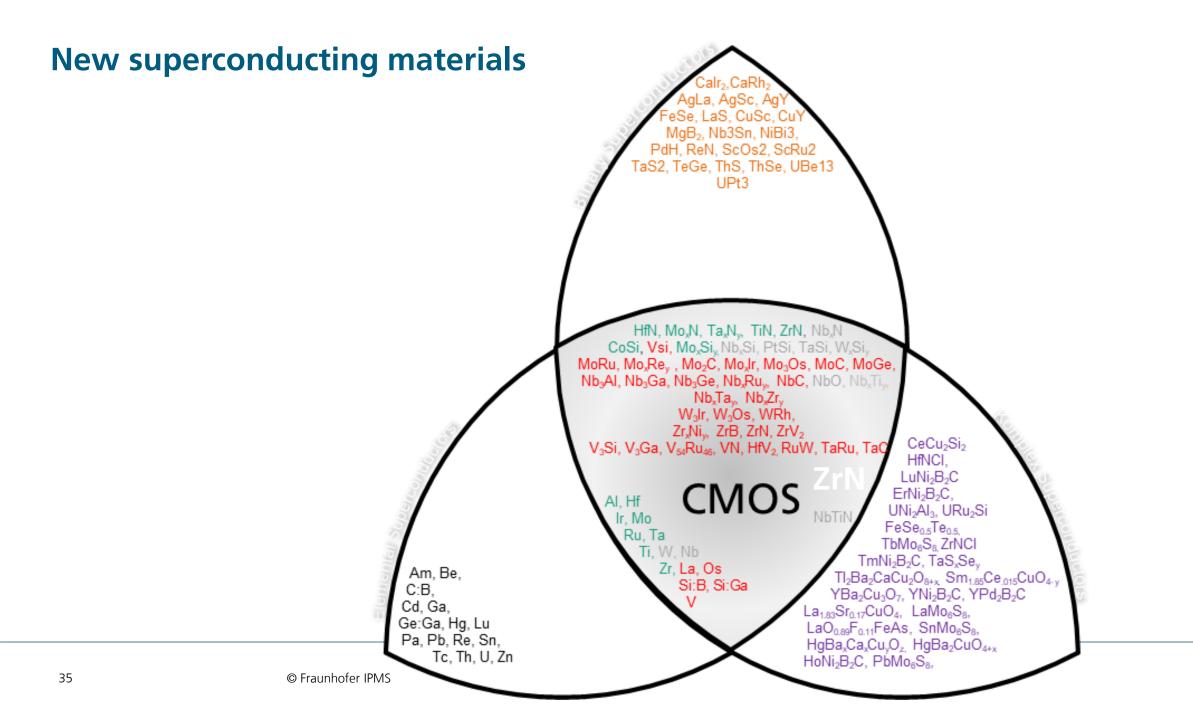
Engagement in QuPilot project for superconducting platform



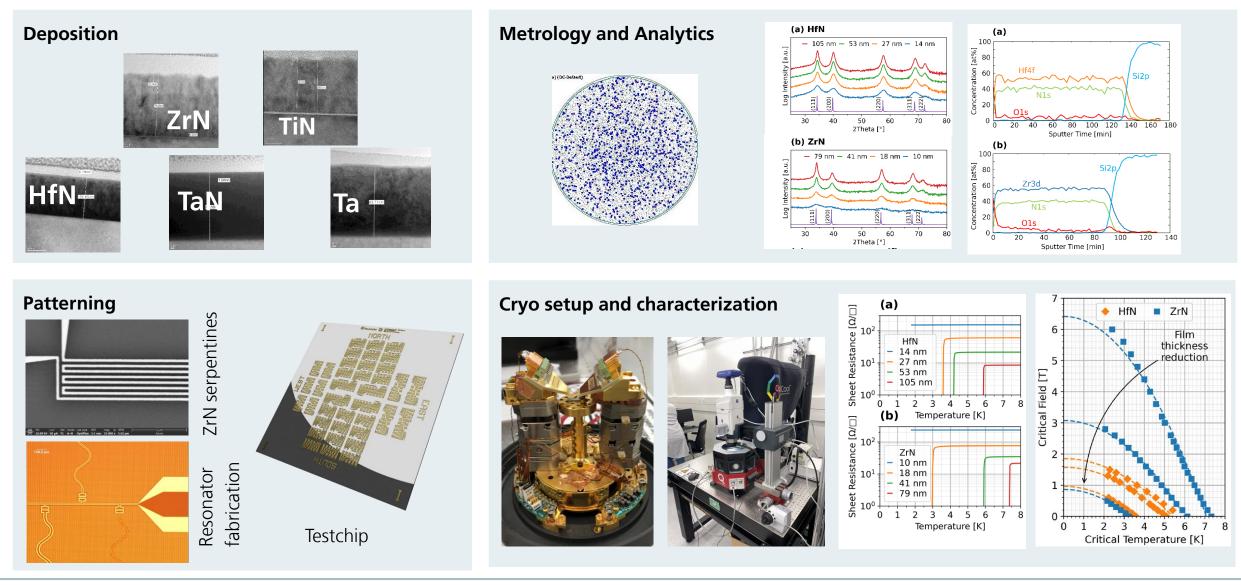
Somm cleanroom at C



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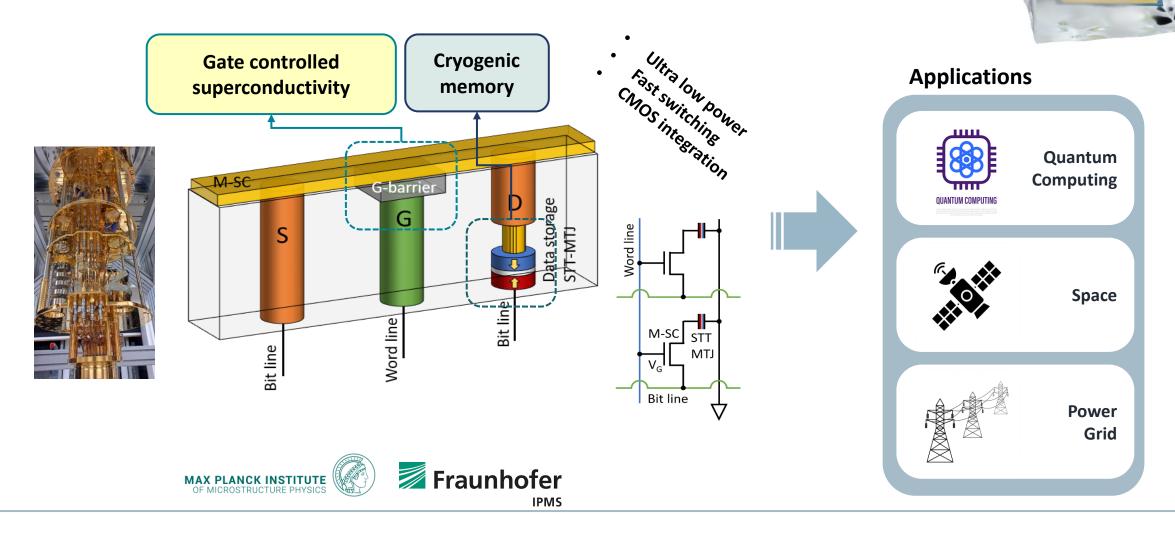


Research on new SC materials



CONDOR concept

Super<u>co</u>nducting spintronic <u>d</u>evices for cryogenic elect<u>r</u>onics



Silicon spin qubits

German 200/300mm QPU line



• Task IPMS:

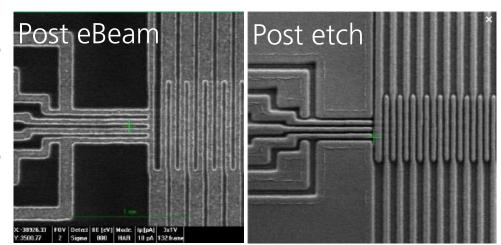
Nanopatterning for q-dots and shuttling concepts, integrated Emicro magnets and gate dielectrics

- 300mm Pilot Line for Quantum Computing (Qu-Pilot project)
- Developing superconducting BEOL with CMOS compatible materials





fine pitch gate patterning



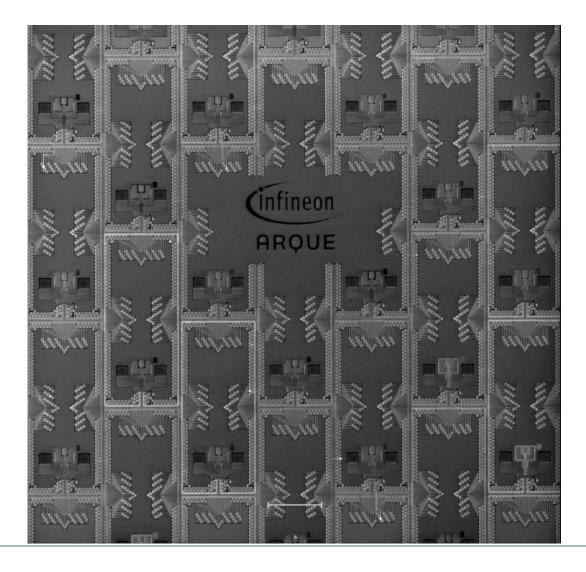




High resolution patterning studies

- eBeam with positive CAR reaching down to 20nm CD
- Stitching possible with <10nm missmatch
- 193nm Litho to eBeam alignment ~ 30nm

• Use in silicon spin qubit manufacturing route with partners



Integration of micro magnets

Deposition of cobalt

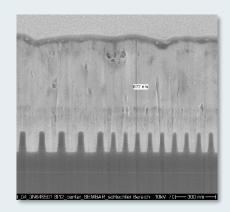




PVD (AMAT "Clover" Endura II)

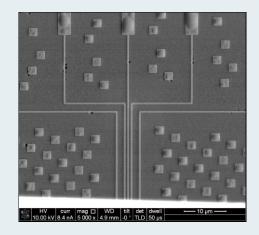


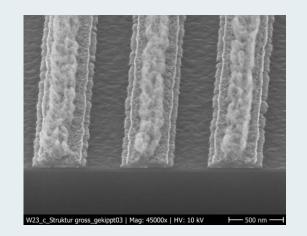
MOCVD (AMAT "Volta")



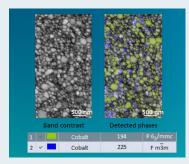
SEM X-section of Co filled trenches

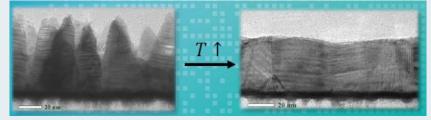
Patterning by RIE





Metrology and Analytics



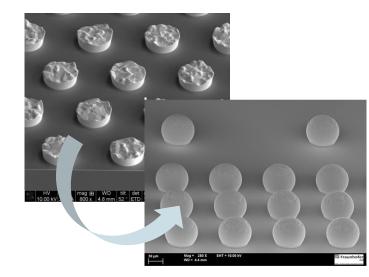


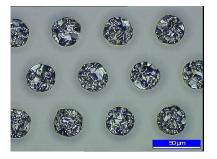
Further examples for modules which need to be looked at

Indium bumping for superconducting packaging options

Cryo chacterization of CMOS logic circuits for qubit control

• E.g. FDSOI technology based



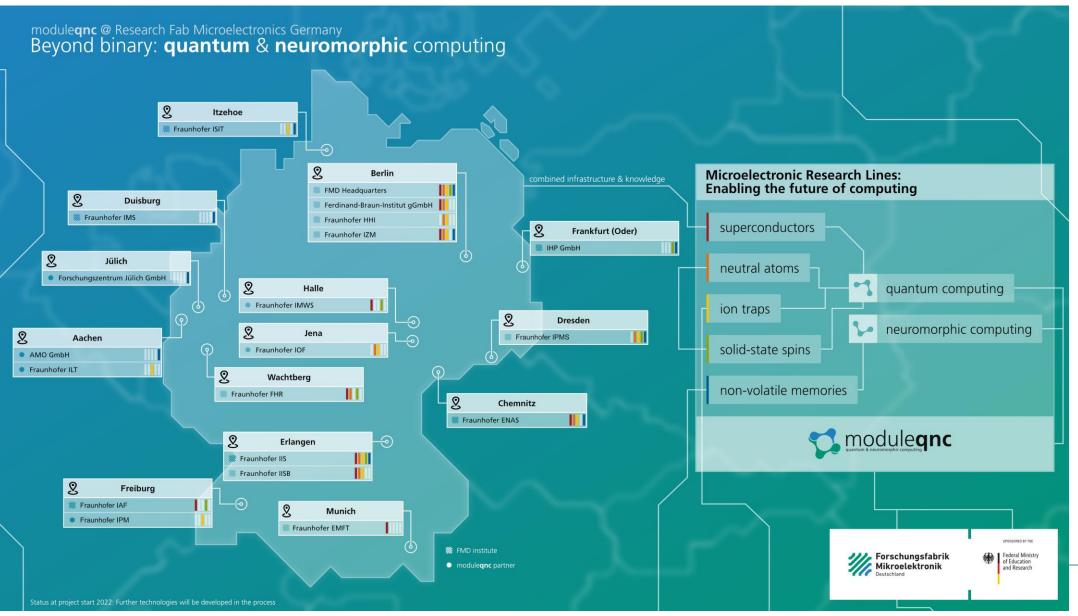






European strategy

How to access those capabilities? Pilotlines !

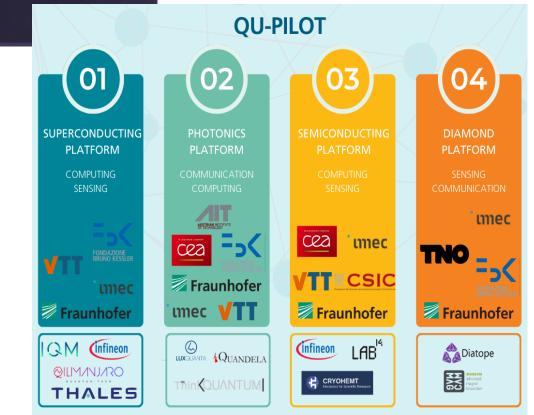


European programs Qu-Pilot & Qu-Test



HIGHLIGHTS 40 PARTNERS

10 COUNTRIES 23 USE CASES OPEN CALL BUDGET OF € 38 MILLIONS ECOSYSTEM PLATFORM PILOT PRODUCTION TESTING & EXPERIMENTATION



Europeans Chips Act

EU Initiatives building the Quantum Ecosystem Equity Investments & €1000 M 👶 Support to Start-ups **Quantum Flagship** Space Gravimetry € 200 M 👶 **TECHNICAL PILLARS** IRIS² (Secure **CROSS-CUTTING ACTIVITIES** Connectivity) EuroQCI ENGINEERING /CONTROL COMMUNIC **SENSING 8** EDUCATION/TRAINING €700 M 🔌 SOFTWARE/THEORY BASIC SCIENCE S Chips Act TBC Joint Undertaking **Pilot Lines** Skills & €25 M 👶 €300 - 400 M 🔔 Education

Summary quantum computing activities USP of Fraunhofer IPMS QC

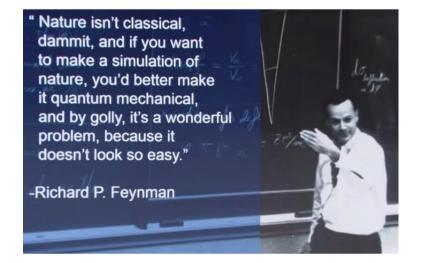
- Close collab with foundry and IDM nearby through established contamination and quality protocols, i.e. foundry- and IDM product wafers can be sent in and out of CNT without further checks !
- only semicon R&D site on 300mm in Germany, high visibility on national level
- close ties to IMEC; CEA-Leti and others
- Strategic commitment from Saxon government for further investments in Quantum Computing technology development towards large scaled systems
- We know how to enable great ideas and scale them on advanced wafer levels in close coop. with industry



Take Away Messages

- Quantum computation sounds weird, but that's just how nature is
- Real quantum advantage still 5-10 years away, currently might need millions of physical qbits

- On the road towards FTQC, quality **and** quantity needs to be improved
- For future larger scaled systems integration on chip/wafer level will be needed
- Microelectronics offers advantages for the whole quantum stack
- Cooperation is needed, key factor: the RTO pilotlines





Thank you, Questions?



Acknowledgement: Roman Potjan (PhD student) Felix Mende (PhD student) Marcus Wislicenus (senior researcher) Varvara Brackmann (senior researcher)